

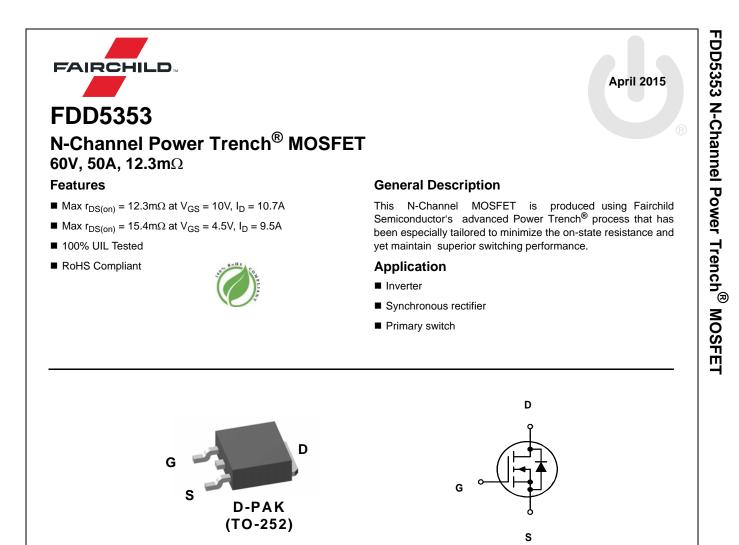
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MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			60	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	$T_{C} = 25^{\circ}C$		50		
	-Continuous	T _A = 25°C	(Note 1a)	11.5	A	
	-Pulsed			100		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	253	mJ	
P _D	Power Dissipation	$T_{\rm C} = 25^{\circ}{\rm C}$		69	W	
	Power Dissipation	T _A = 25°C	(Note 1a)	3.1		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

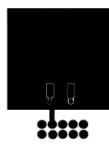
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.8	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a)	40	C/vv

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD5353	FDD5353	D-PAK (TO-252)	13"	16mm 2500 i	

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0 V$	60			V
$\Delta BV_{DSS} \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu$ A, referenced to 25°C		77		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{GS} = 0V, V_{DS} = 48V,$			1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	1.0	1.8	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		-8		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10V, I _D = 10.7A		10.1	12.3	
		$V_{GS} = 4.5V, I_D = 9.5A$	12.1 15.4		15.4	mΩ
		V _{GS} = 10V, I _D = 10.7A, T _J = 125°C		16.7	20.3	
9 _{FS}	Forward Transconductance	V _{DD} = 5V, I _D = 10.7A		41		S
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz		2420 215 120	3215 285 180	pF pF pF
R _g	Gate Resistance	f = 1MHz		1.7		Ω
Switching	g Characteristics					
	,					
t _{d(on)}	Turn-On Delay Time			11	20	ns
t _{d(on)} t _r		V _{DD} = 30V, I _D = 10.7A,		11 6	20 11	ns ns
	Turn-On Delay Time	$V_{DD} = 30V, I_D = 10.7A,$ $V_{GS} = 10V, R_{GEN} = 6\Omega$			-	
t _r	Turn-On Delay Time Rise Time	$V_{GS} = 10V, R_{GEN} = 6\Omega$		6	11	ns
t _r t _{d(off)}	Turn-On Delay Time Rise Time Turn-Off Delay Time	$V_{GS} = 10V, R_{GEN} = 6\Omega$		6 36	11 58	ns ns
t _r t _{d(off)} t _f Q _g	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{GS} = 10V, R_{GEN} = 6\Omega$		6 36 4	11 58 10	ns ns ns
t _r t _{d(off)} t _f Q _g	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge			6 36 4 46	11 58 10 65	ns ns ns nC
t _r t _{d(off)} t _f Q _g Q _g	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	$V_{GS} = 10V, R_{GEN} = 6\Omega$		6 36 4 46 23	11 58 10 65	ns ns ns nC nC
t _r t _{d(off)} C _g C _g C _{gs} C _{gg}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge	$V_{GS} = 10V, R_{GEN} = 6\Omega$		6 36 4 46 23 7	11 58 10 65	ns ns nC nC nC
t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd} Drain-Sou	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	$V_{GS} = 10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } 10V$ $V_{DD} = 30V,$ $I_D = 10.7A$ $V_{GS} = 0V, I_S = 10.7A \text{ (Note 2)}$		6 36 4 46 23 7	11 58 10 65	ns ns nC nC nC
t _r t _{d(off)} C _g C _g C _{gs} C _{gg}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	$V_{GS} = 10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } 10V$ $V_{DD} = 30V,$ $I_{D} = 10.7A$		6 36 4 46 23 7 9	11 58 10 65 32	ns ns nC nC nC
t_r $t_{d(off)}$ t_f Q_g Q_g Q_{gs} Q_{gd} Drain-Sou	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	$V_{GS} = 10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } 10V$ $V_{DD} = 30V,$ $I_D = 10.7A$ $V_{GS} = 0V, I_S = 10.7A \text{ (Note 2)}$		6 36 4 23 7 9 0.8	11 58 10 65 32 1.3	ns ns nC nC nC

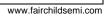
Notes: 1: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0JA} is determined by the user's board design.



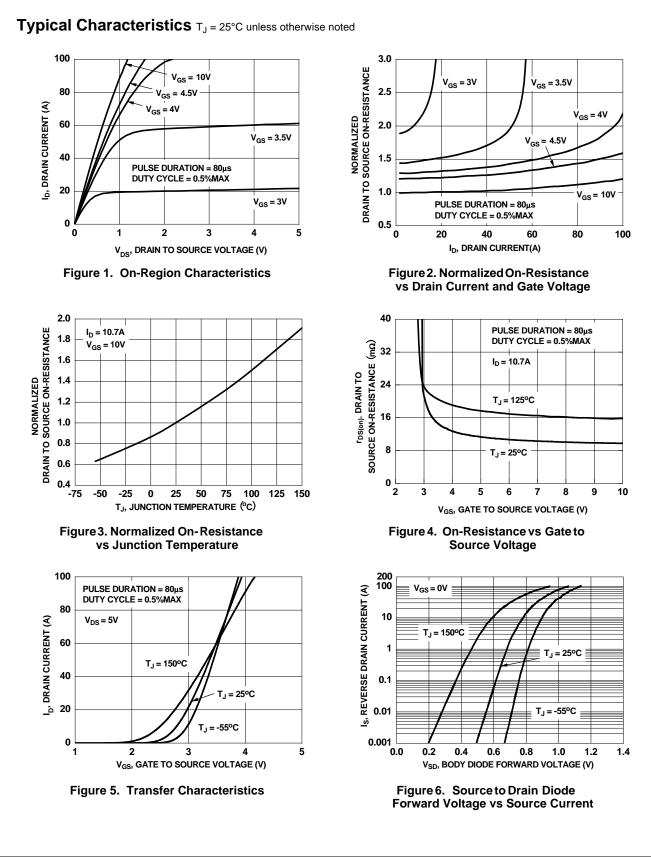
a) 40°C/W when mounted on a 1 in² pad of 2 oz copper



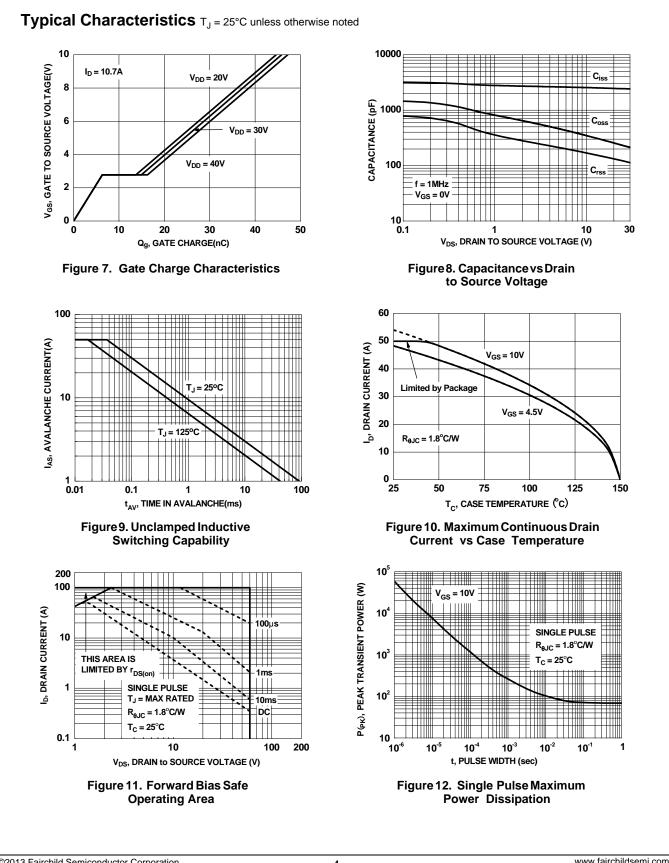
b) 96°C/W when mounted on a minimum pad.



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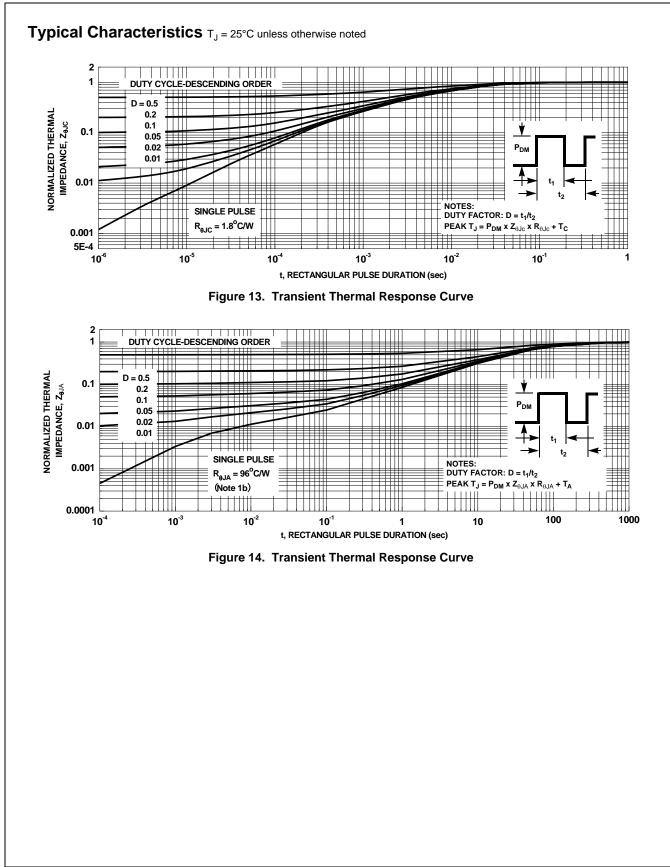
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